

L Number	Hits	Search Text	DB	Time stamp
541	1	("5980683").PN.	USPAT	2002/03/21 14:55
542	33137	(thermoplastic or thermosetting) with (epoxy or polyimide or bt)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/21 15:10
543	2688	((thermoplastic or thermosetting) with (epoxy or polyimide or bt)) and chip	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/21 15:04
544	964	((thermoplastic or thermosetting) with (epoxy or polyimide or bt)) and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/21 15:10
546	129	(thermoplastic or thermosetting) with bt	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/21 15:11
545	250	((((thermoplastic or thermosetting) with (epoxy or polyimide or bt)) and 257/\$.ccls.) and carrier	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/21 15:23
547	1	("5980683").PN.	USPAT	2002/03/21 15:22
548	120	((((thermoplastic or thermosetting) with (epoxy or polyimide or bt)) and 257/\$.ccls.) and carrier) and (rigid or strong or hard or reinforce)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/21 15:43
549	1	("5023202").PN.	USPAT	2002/03/21 15:44
550	1	("5023202").PN.	USPAT	2002/03/21 16:36
551	1	("5286679").PN.	USPAT	2002/03/21 16:37